**New Product** 



Vishay General Semiconductor

# **SMD** Photovoltaic Solar Cell Protection Rectifier



0-2//A (SMPC)

Cathode

PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	5.0 A			
V <sub>RRM</sub>	1000 V			
I <sub>FSM</sub>	100 A			
I <sub>R</sub>	10 µA			
V <sub>F</sub> at I <sub>F</sub> = 5.0 A	0.90 V			
T <sub>J</sub> max.	150 °C			

#### FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Glass passivated chip junction
- Low forward voltage drop
- High forward surge capability
- Low thermal resistance
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

### **TYPICAL APPLICATIONS**

For use in solar cell panel blocking diode for protection, using DC forward current without reverse bias.

### **MECHANICAL DATA**

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	S5PMS	UNIT	
Device marking code			5PMS		
Maximum repetitive peak reverse voltage		V <sub>RRM</sub>	1000	V	
Maximum DC forward current (fig. 1)	T <sub>M</sub> = 130 °C	I <sub>F</sub>	5.0 <sup>(1)</sup>		
	T <sub>A</sub> = 25 °C		1.8 (2)	A	
Peak forward surge current 10 ms single half sine-v superimposed on rated load	I <sub>FSM</sub> 100		А		
Operating junction and storage temperature range		T <sub>OP</sub> , T <sub>STG</sub>	- 55 to + 150	°C	
Junction temperature in DC forward current without reverse bias, t $\leq$ 1 h $^{(3)}$		TJ	≤ 200	°C	

Notes

<sup>(1)</sup> Mounted on 30 mm x 30 mm AI PCB

<sup>(2)</sup> Free air, mounted on recommended copper pad area

<sup>(3)</sup> Meets the requirements of IEC 61215 Ed. 2 bypass diode thermal test

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# S5PMS



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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25$ °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.94	-	V	
	I <sub>F</sub> = 5.0 A			0.99	1.15		
	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 125 °C		0.82	-		
	I <sub>F</sub> = 5.0 A			0.90	1.00		
Reverse current	Rated V <sub>B</sub>	T <sub>A</sub> = 25 °C	- I <sub>R</sub> <sup>(2)</sup>	-	10	μA	
	naleu v <sub>R</sub>	T <sub>A</sub> = 125 °C		55	100		
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t <sub>rr</sub>	2.5	-	μs	
Typical junction capacitance	4.0 V, 1 MHz		CJ	30	-	pF	

#### Notes

<sup>(1)</sup> Pulse test: 300 µs pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  40 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	S5PMS	UNIT		
Typical thermal resistance	$R_{\theta JA}$ <sup>(1)</sup>	90	°C/W		
	R <sub>0JM</sub> <sup>(2)</sup>	3			

Notes

 $^{(1)}$  Free air, mounted on recommended copper pad area. Thermal resistance  $R_{\theta JA}$  - junction to ambient

 $^{(2)}$  Mounted on 30 mm x 30 mm AI PCB Thermal resistance  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
S5PMS-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel		
S5PMS-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel		

#### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

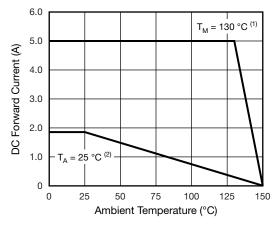


Fig. 1 - Forward Current Derating Curve

#### Notes

- $^{(1)}$  Mounted on 30 mm x 30 mm Al PCB  $T_M$  measured at the terminal (R\_{\theta JM} = 3.0  $^\circ C/W)$
- $^{(2)}$  Free air, mounted on recommended copper pad area  $(R_{\theta,JA}$  = 90 °C/W)

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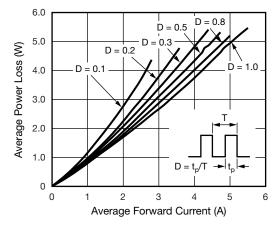


Fig. 2 - Forward Power Loss Characteristices

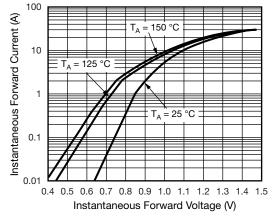


Fig. 3 - Typical Instantaneous Forward Characteristics

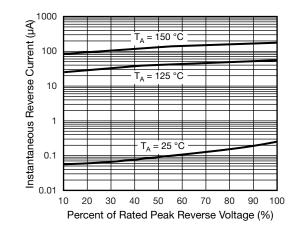
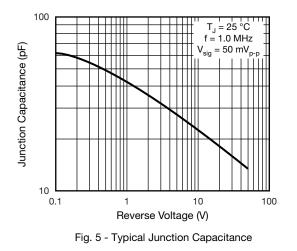


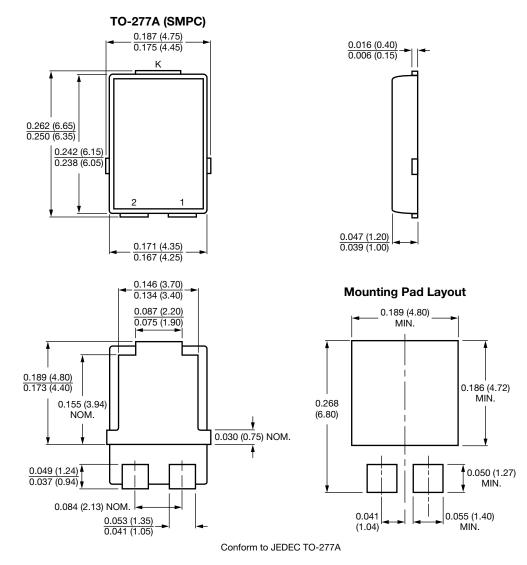
Fig. 4 - Typical Reverse Leakage Characteristics



## S5PMS

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### PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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